NPN Silicon Epitaxial Transistor

BCP56 Series

These NPN Silicon Epitaxial transistors are designed for use in audio amplifier applications. The device is housed in the SOT−223 package, which is designed for medium power surface mount applications.

Features

- High Current: 1.0 A
- The SOT−223 package can be soldered using wave or reflow. The formed leads absorb thermal stress during soldering, eliminating the possibility of damage to the die
- Available in 12 mm Tape and Reel
  Use BCP56T1G to Order the 7 inch/1000 Unit Reel
  Use BCP56T3G to Order the 13 inch/4000 Unit Reel
- PNP Complement is BCP53T1G
- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q101 Qualified and PPAP Capable
- These Devices are Pb−Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Collector−Emitter Voltage	V_{CEO}	80	Vdc
Collector−Base Voltage	V_{CBO}	100	Vdc
Emitter−Base Voltage	V_{EBO}	5	Vdc
Collector Current	I_C	1	Adc
Collector Current − Peak (Note 1)	I_{CM}	2	Adc
Total Power Dissipation @ T_A = 25°C (Note 2) Derate above 25°C	P_D	 1.5 12	 W mW/°C
Operating and Storage Temperature Range	T_J, T_{stg}	−65 to 150	°C

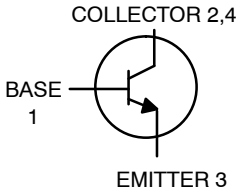
THERMAL CHARACTERISTICS

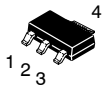
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction−to−Ambient (surface mounted)	$R_{\theta JA}$	83.3	°C/W
Maximum Temperature for Soldering Purposes Time in Solder Bath	T_L	 260 10	 °C Sec

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Reference SOA curve.
2. Device mounted on a FR−4 glass epoxy printed circuit board 1.575 in x 1.575 in x 0.0625 in; mounting pad for the collector lead = 0.93 sq in.

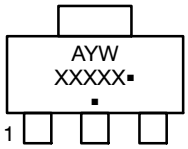
MEDIUM POWER NPN SILICON HIGH CURRENT TRANSISTOR SURFACE MOUNT





SOT−223
CASE 318E
STYLE 1

MARKING DIAGRAM



XXXXX = Specific Device Code
A = Assembly Location
Y = Year
W = Work Week
▪ = Pb−Free Package
(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 5.

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristics		Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Collector−Base Breakdown Voltage (I_C = 100 μAdc, I_E = 0)		$V_{(BR)CBO}$	100	–	–	Vdc
Collector−Emitter Breakdown Voltage (I_C = 1.0 mAdc, I_B = 0)		$V_{(BR)CEO}$	80	–	–	Vdc
Emitter−Base Breakdown Voltage (I_E = 10 μAdc, I_C = 0)		$V_{(BR)EBO}$	5.0	–	–	Vdc
Collector−Base Cutoff Current (V_{CB} = 30 Vdc, I_E = 0)		I_{CBO}	–	–	100	nAdc
Emitter−Base Cutoff Current (V_{EB} = 5.0 Vdc, I_C = 0)		I_{EBO}	–	–	10	μAdc
ON CHARACTERISTICS (Note 3)						
DC Current Gain		h_{FE}				–
(I_C = 5.0 mA, V_{CE} = 2.0 V)	All Part Types		25	–	–	
(I_C = 150 mA, V_{CE} = 2.0 V)	BCP56		40	–	250	
	BCP56−10		63	–	160	
	BCP56−16		100	–	250	
(I_C = 500 mA, V_{CE} = 2.0 V)	All Types		25	–	–	
Collector−Emitter Saturation Voltage (I_C = 500 mAdc, I_B = 50 mAdc)		$V_{CE(sat)}$	–	–	0.5	Vdc
Base−Emitter On Voltage (I_C = 500 mAdc, V_{CE} = 2.0 Vdc)		$V_{BE(on)}$	–	–	1.0	Vdc
SWITCHING CHARACTERISTICS						
Rise Time (V_{CC} = 30 Vdc, I_C = 150 mA, I_{B1} = 15 mA)		t_r	–	14	–	ns
Delay Time (V_{CC} = 30 Vdc, I_C = 150 mA, I_{B1} = 15 mA)		t_d	–	9	–	ns
Storage Time (V_{CC} = 30 Vdc, I_C = 150 mA, I_{B1} = 15 mA, I_{B2} = 15 mA)		t_s	–	714	–	ns
Fall Time (V_{CC} = 30 Vdc, I_C = 150 mA, I_{B1} = 15 mA, I_{B2} = 15 mA)		t_f	–	58	–	ns
DYNAMIC CHARACTERISTICS						
Current−Gain − Bandwidth Product (I_C = 10 mAdc, V_{CE} = 5.0 Vdc, f = 35 MHz)		f_T	–	130	–	MHz

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%

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TYPICAL ELECTRICAL CHARACTERISTICS

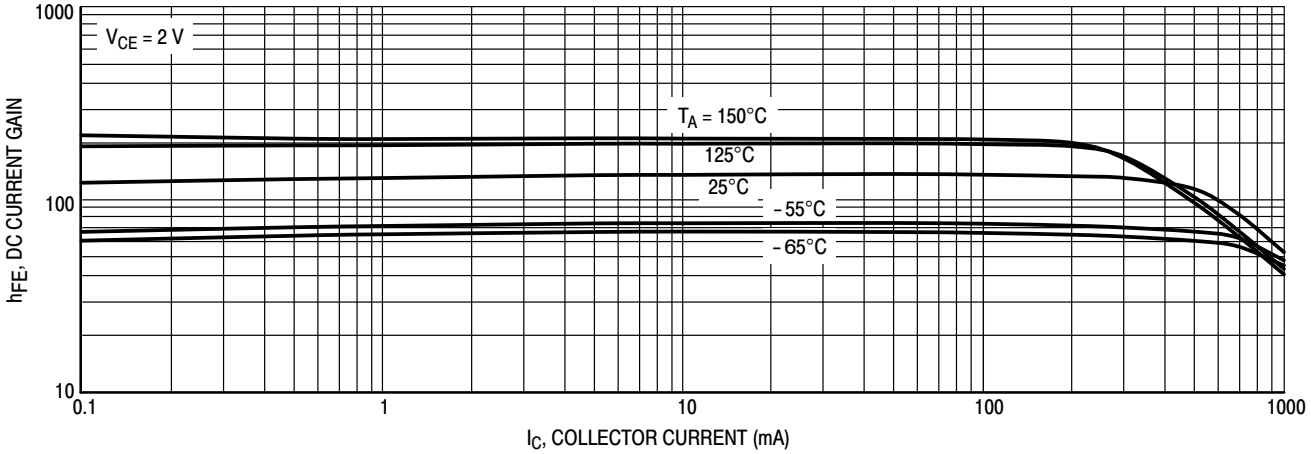

Figure 1. DC Current Gain

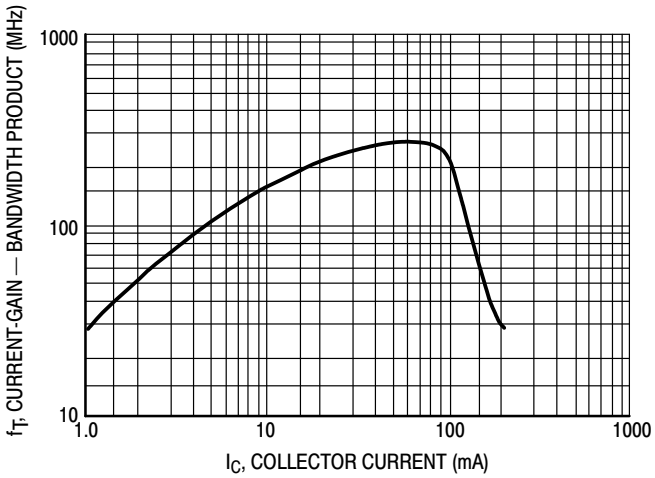

Figure 2. Current−Gain − Bandwidth Product

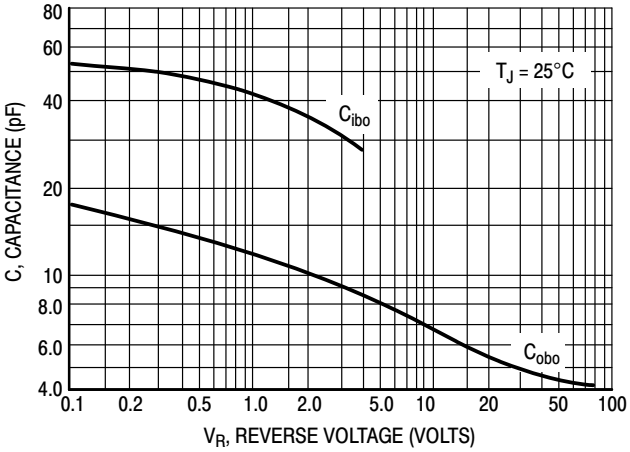

Figure 3. Capacitance

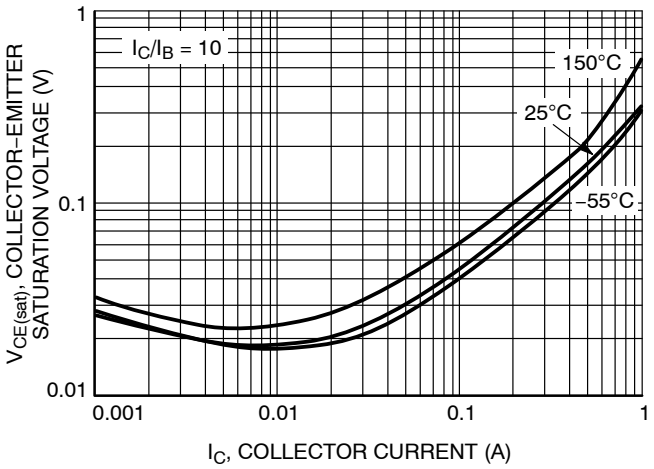

Figure 4. Collector Emitter Saturation Voltage vs. Collector Current

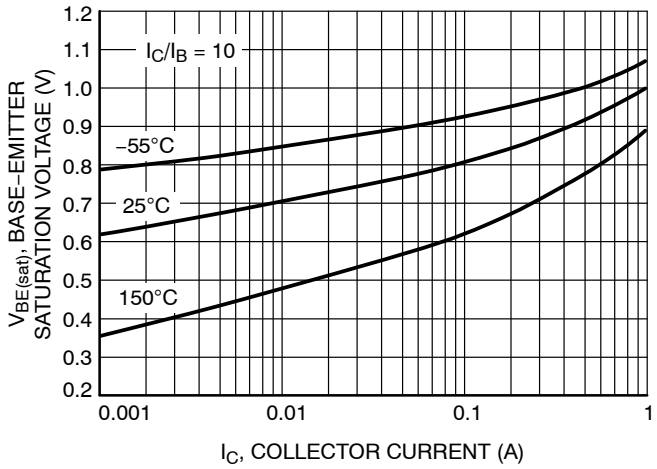

Figure 5. Base Emitter Saturation Voltage vs. Collector Current

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TYPICAL ELECTRICAL CHARACTERISTICS

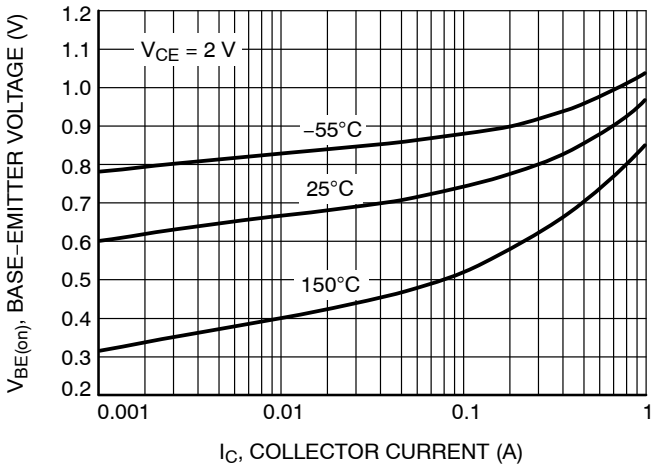

Figure 6. Base Emitter Voltage vs. Collector Current

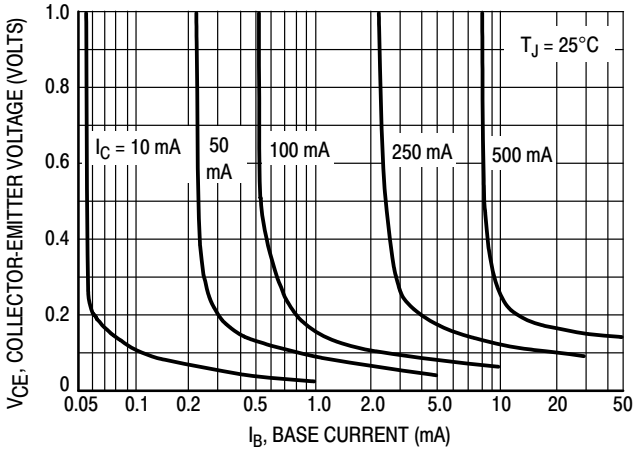

Figure 7. Collector Saturation Region

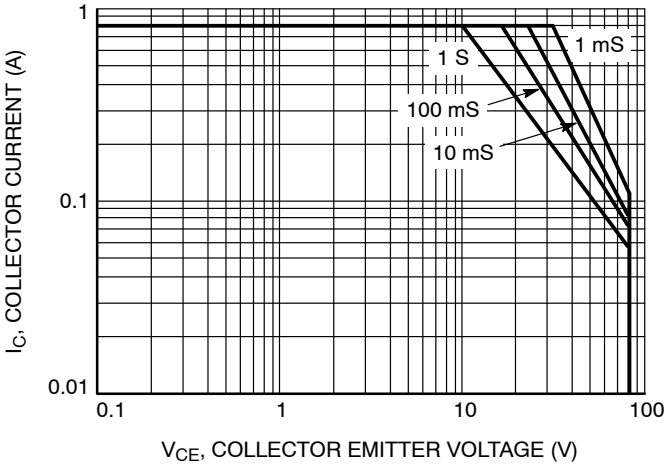

Figure 8. Safe Operating Area

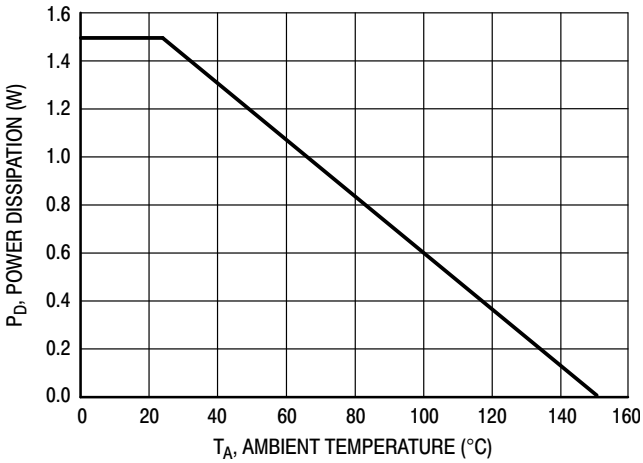

Figure 9. Power Derating Curve

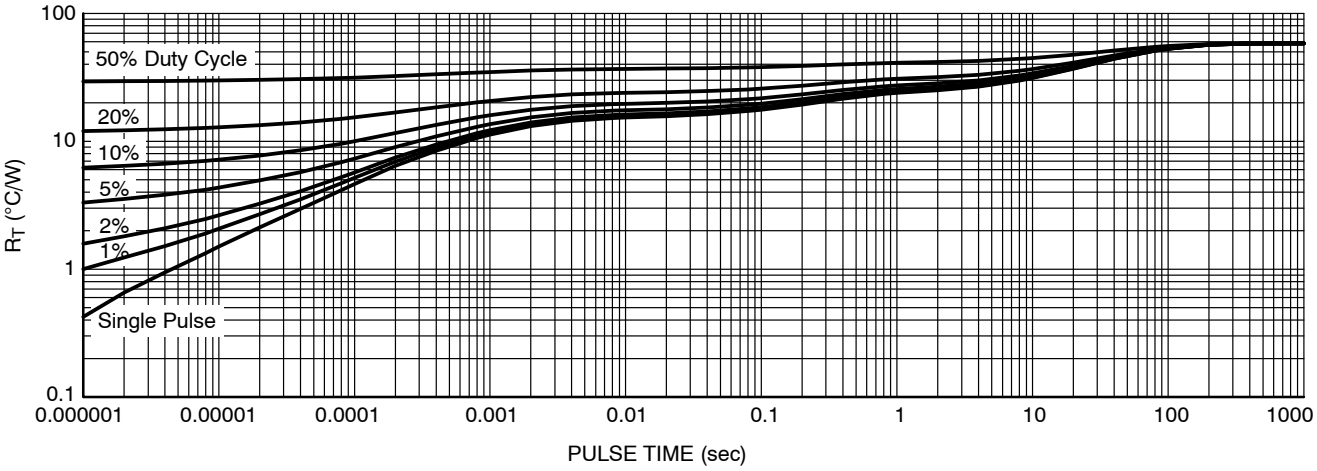

Figure 10. Thermal Response

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ORDERING INFORMATION

Device	Marking	Package	Shipping†
BCP56T1G	BH	SOT−223 (Pb−Free)	1000 / Tape & Reel
SBCP56T1G*			
BCP56T3G	BH	SOT−223 (Pb−Free)	4000 / Tape & Reel
SBCP56T3G*			
BCP56−10T1G	BH−10	SOT−223 (Pb−Free)	1000 / Tape & Reel
SBCP56−10T1G*			
NSVBCP56−10T3G*	BH−10	SOT−223 (Pb−Free)	4000 / Tape & Reel
BCP56−16T1G	BH−16	SOT−223 (Pb−Free)	1000 / Tape & Reel
SBCP56−16T1G*			
BCP56−16T3G	BH−16	SOT−223 (Pb−Free)	4000 / Tape & Reel
SBCP56−16T3G*			

DISCONTINUED (Note 4)

BCP56−10T3G	BH−10	SOT−223 (Pb−Free)	4000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q101 Qualified and PPAP Capable.

4. **DISCONTINUED:** This device is not recommended for new design. Please contact your **onsemi** representative for information. The most current information on this device may be available on www.onsemi.com.

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